

NCE2025S

## NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE2025S uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

●V<sub>DS</sub> =20V,I<sub>D</sub> =25A

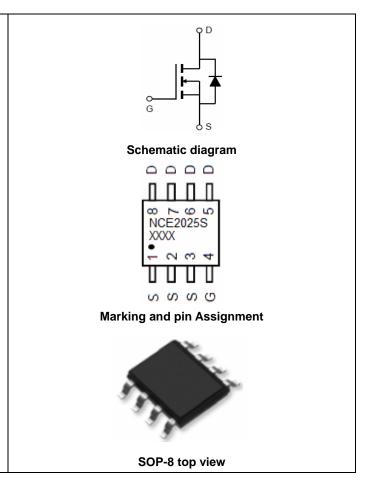
 $R_{DS(ON)} < 4m\Omega @ V_{GS} = 4.5V$ 

 $R_{DS(ON)} < 6m\Omega$  @  $V_{GS}$ =2.5V

- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current

### **Application**

- DC/DC Converter
- Battery protection



**Package Marking and Ordering Information** 

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE2025S	NCE2025S	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T<sub>4</sub>=25 °C unless otherwise noted)

About the Maximum Ratings (TA-20 Sumose Striet Miss Hotsul)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	20	V		
Gate-Source Voltage	V <sub>G</sub> s	±12	V		
Drain Current-Continuous	I <sub>D</sub>	25	А		
Drain Current-Continuous(T <sub>A</sub> =100 °C)	I <sub>D</sub> (100℃)	17.7	А		
Pulsed Drain Current	I <sub>DM</sub>	140	А		
Maximum Power Dissipation	P <sub>D</sub>	2.5	W		
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	°C		

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	50	°C/W
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## NCE2025S

Electrical Characteristics (T<sub>A</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA 20		-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	0.5	0.75	1.2	V	
Drain-Source On-State Resistance	Б	$V_{GS}$ =4.5V, $I_D$ =20A	-	3.5	4	mΩ	
Diam-Source On-State Resistance	$R_{DS(ON)}$	V <sub>GS</sub> =2.5V, I <sub>D</sub> =18A		4.2	6	11152	
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	60	-	-	S	
Dynamic Characteristics (Note4)			•				
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V,	-	5300	-	PF	
Output Capacitance	C <sub>oss</sub>	F=1.0MHz	-	785	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	1 - 1.0WH2	-	629	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS	
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =10V, $R_L$ =0.5 $\Omega$	-	12	-	nS	
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS}$ =4. 5V, $R_{GEN}$ =3 $\Omega$	-	50	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	20	-	nS	
Total Gate Charge	Qg	V <sub>DS</sub> =10V,I <sub>D</sub> =20A,	-	64.9	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> -10V,I <sub>D</sub> -20A, V <sub>GS</sub> =4.5V	-	6.5	-	nC	
Gate-Drain Charge	$Q_{gd}$	V GS-4.5 V	-	13.8	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =25A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	25	Α	

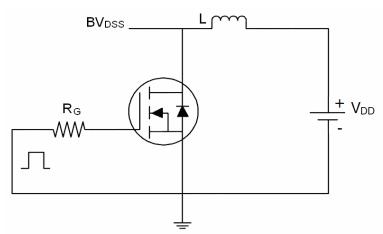
#### Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

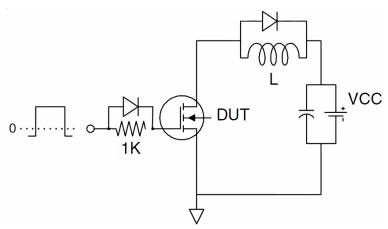
## NCE2025S

## **Test Circuit**

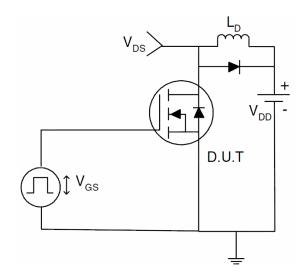
## 1) E<sub>AS</sub> Test Circuits



## 2) Gate Charge Test Circuit



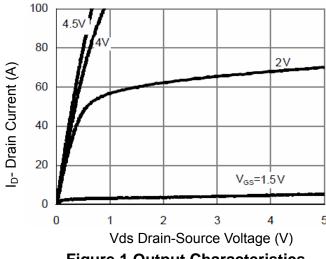
### 3) Switch Time Test Circuit



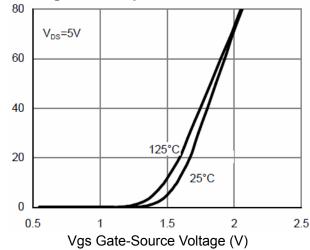
**Pb Free Product** 



## **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



Ip- Drain Current (A)

Resistance(Ω)

**Figure 2 Transfer Characteristics** 

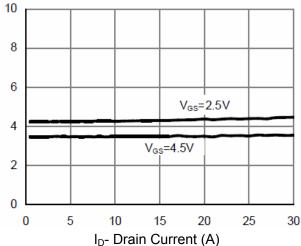
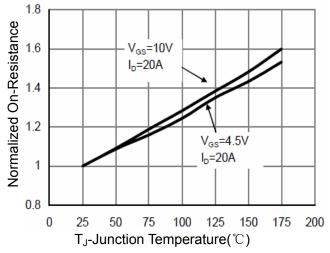


Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 

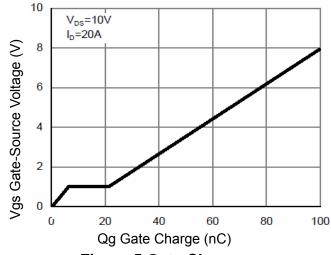


Figure 5 Gate Charge

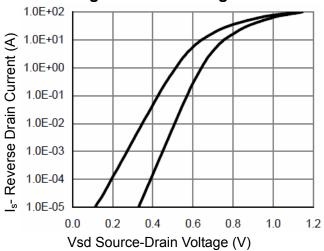


Figure 6 Source- Drain Diode Forward



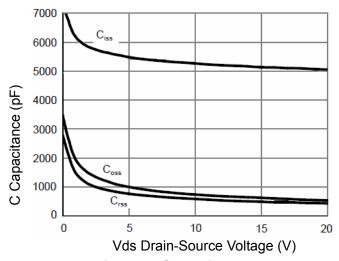


Figure 7 Capacitance vs Vds

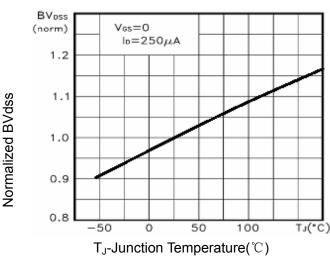
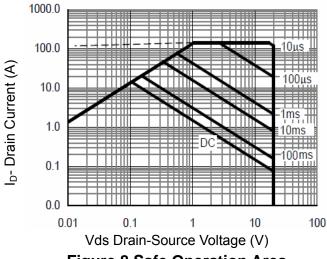
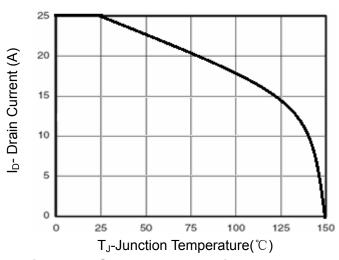


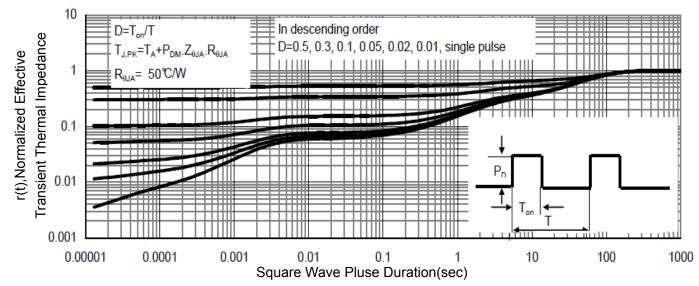
Figure 9 BV<sub>DSS</sub> vs Junction Temperature



**Figure 8 Safe Operation Area** 



**Figure 10 Current vs Junction Temperature** 



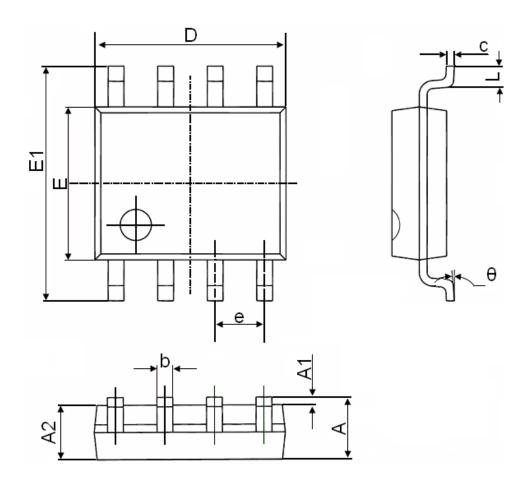
**Figure 11 Normalized Maximum Transient Thermal Impedance** 

**Pb Free Product** 



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## **SOP-8 Package Information**



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	1.270(BSC)		(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



#### http://www.ncepower.com

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